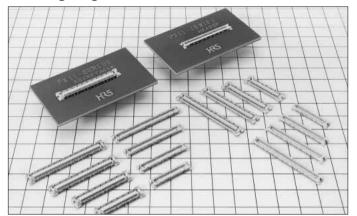
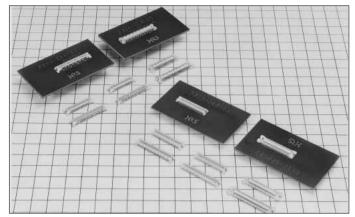
0.5mm Pitch Connectors with Ground Plate for 2mm to 3mm Board-to-Board Connections

FX11 Series

Stacking height: 2mm



Stacking height: 2.5mm, 3mm



■Features

1. Low Profile Design

The board to board mating height of 2mm, 2.5mm and 3mm suits smaller, thinner case designs.

2. Improved Transmission Efficiency Between Boards

Transmission characteristics have been improved through a design that fixes ground plates to both sides of the header and receptacle.

3. 10 Signal: 1 Ground Arrangement

Signal and ground are arranged in a ratio of 10:1 with the ground plate SMT connected to the board. The ground stability achieved serves to reduce noise.

4. Metal Fittings for Added Solder Weld Strength

Metal fittings provide greater adhesion to the board. protecting against peeling. The unique connector design provides a connection between the fitting and the ground plate for a stronger ground.

5. Suited to High-Density Applications

The signal contact pitch of 0.5mm produces a smaller connector utilizing less board area for mounting.

6. Structure Prevents Solder Wicking

A solder gap has been designed into the contact SMT portion to prevent solder wicking.

7. High contact reliability

Effective mating length is 0.55mm (2mm height), 1mm(2.5mm, 3mm height) for signal contacts.

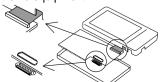
8. Optional Ground Plate

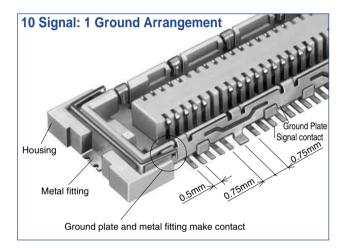
An alternate style without the ground plate is available. The space provided by the ground plate removal has been filled with additional signal contacts.

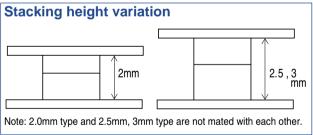
Applications

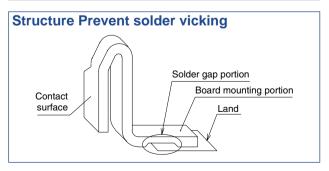
Notebook computers, PDA, and other miniature electronic equipment.











●Stacking height variation

With ground plate

Receptacle Header	FX11L#-%P / %-SV
FX11L#-%S / %-SV	2mm

Receptacle Header	FX11#-%P / %-SV	FX11#-%P / %-SV0.5
FX11#-%S / %-SV	2.5mm	3mm

Without ground plate

Receptacle Header	FX11L#-%P-SV
FX11L#-%S-SV	2mm

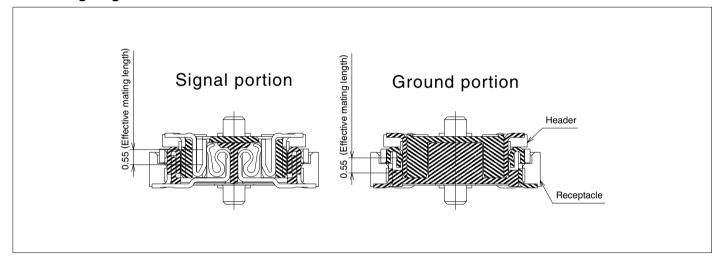
Receptacle	FX11#-%P-SV	FX11#-%P-SV0.5
FX11#-%S-SV	2.5mm	3mm

Note 1: The thickness of the solder paste is not included in the stacking height.

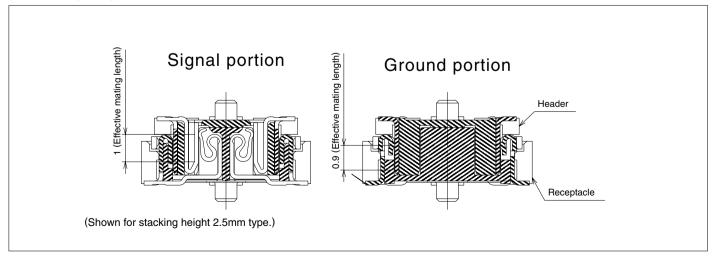
Note 2: 2mm type and 2.5mm, 3mm type, with ground plate type and without ground type are not mated with each other.

●Cross section of mating

● Stacking height: 2mm



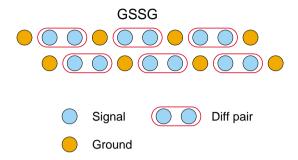
Stacking height: 2.5mm, 3mm



■Signal integrity

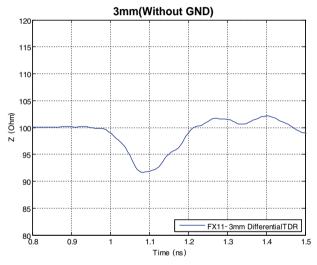
Pin assignment

To match 100 ohm differential impedance and to reduce crosstalk, a staggered GSSG pin assignment is recommended.(G=ground and S=signal)



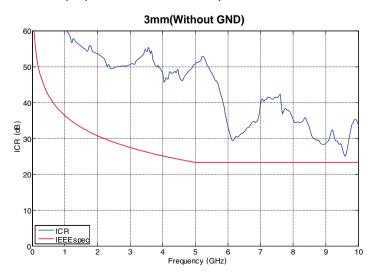
●Impedance

The differential impedance is 100 +/- 10 ohm for FX11 at 50 ps rise time(20% to 80%).



●Insertion-loss-to-crosstalk ratio (ICR)

The insertion-loss-to-crosstalk ratio (ICR) with five differential FEXT aggressors meets the extrapolated IEEE802.3ap specification to 10⁺ Gbps.



Stacking height: 2mm

■Product Specifications

	Rated current	0.3 A (Note 1)	Operating temperature range	-55 to 85℃	Storage temperature range	-10 to +60°C (Note 2)
Rating	Rated voltage	50 V AC	Operating humidity range	Relative humidity 95% or less	Storage humidity range	40 to 70% (Note 2)
				(No condensation)		

Item	Requirements	Conditions
1. Insulation resistance	100 MΩ or greater	Measured at 100 V DC
2. Voltage proof	No flashover or breakdown	150 V AC applied for one minute
3. Contact resistance	60 mΩ or less	Measured at 100 mA
4. Vibration	No electrical discontinuity for $1\mu s$ or greater No damage, cracks, or parts looseness	Frequency: 10 to 55 Hz, amplitude of 0.75 mm in 3 directions, 10 cycles each
5. Shock	No electrical discontinuity for 1 μ s or longer No damage, cracks, or parts looseness	Acceleration of 490 m/s², 11ms duration, sine half-wave waveform, for 3 cycles in the both directions of each of the 3 axes
6. Damp heat (Steady state)	Contact resistance of 70 m Ω or less, insulation resistance of 100 M Ω or greater, no damage, cracks, or parts looseness	Temperature of 40°C, humidity of 90 to 95%, duration 96 h
7. Temperature cycle	Contact resistance of 70 m Ω or less, insulation resistance of 100 M Ω or greater, no damage, cracks, or parts looseness	Temperature: $-55^{\circ}\text{C} \rightarrow 15 \text{ to } 35^{\circ}\text{C} \rightarrow 85^{\circ}\text{C} \rightarrow 15 \text{ to } 35^{\circ}\text{C}$ Time: 30 min. \rightarrow 2 to 3 min. \rightarrow 30 min. \rightarrow 2 to 3 min. for 5 cycles
8. Durability	Contact resistance of 70 mΩ or less No damage, cracks, or parts looseness	50 times
Resistance to soldering heat	No melting of resin portion which affects performance	Reflow: At the recommended temperature profile Soldering iron temperature: 360°C for 5 seconds

Note 1: The term storage refers to an unused products prior to board mounting (including packing materials) that is being kept for a long period. The operating temperature and humidity range are applied to the non-conducting condition following board assembly.

■Materials

Part	Material		Remarks	
Insulator	LCP	Beige		UL94V-0
Contacto	Copper alloy	Header	Engagement Area: Gold plating of $0.1\mu m$	
Contacts	Phosphor bronze	Receptacle	Termination Area: Flash plating	
Ground plate	Phosphor bronze	Tin plating		
Metal fitting	Dhoonhar bronzo	Tip ploting		
Metal plate	Phosphor bronze	Tin plating		

■Ordering information

Type With Ground Plate
$$\frac{FX11L}{\bullet} = \frac{\#}{2} - \frac{\#}{4} - \frac{\#}{4} - \frac{SV}{\bullet} = \frac{SV}{\bullet} = \frac{(**)}{\bullet}$$
Type Without Ground Plate
$$\frac{FX11L}{\bullet} = \frac{\#}{2} - \frac{\#}{6} = \frac{SV}{\bullet} = \frac{(**)}{\bullet}$$

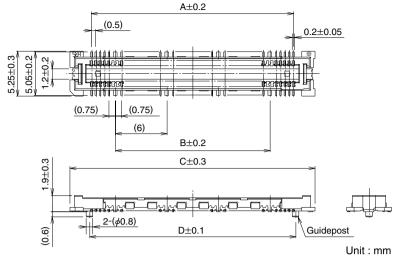
0	Series name : FX11L	4	Connector type
2	Form Symbol A: With guide post		P : Header
	B : Without guide post		S : Receptacle
Number of contacts Type with ground plate			Contact form
	Signal/Ground:60/6, 80/8,		SV : Straight SMT
	100/10, 120/12	6	Blank, (71): Tray packaging (Without pick-and-place tape)
	Type without ground		(21),(91): Embossed tape packaging (Without pick-and-place tape)
	Signal: 68, 92, 116, 140		(22),(92): Embossed tape packaging (With pick-and-place tape)

Note 2: Information contained in this catalog represents general requirements for this Series. Contact us for the drawings and specifications for a specific part number shown.

■Header with ground Plate

2mm stacking height





Dort Number	CL No.	Number o	of contacts	АВ		_	_	F	Remarks	Dallo	
Part Number	CL NO.	Signal	Ground	A	A B		D	E	F	nemarks	RoHS
FX11LA- 60P/ 6-SV(71)	573-0002-7-71	60	6	17.5	12	22.6	18	19.4	25.5		
FX11LA- 80P/ 8-SV(71)	573-0003-0-71	80	8	23.5	18	28.6	24	25.4	31.5	With guidenests	
FX11LA-100P/10-SV(71)	573-0004-2-71	100	10	29.5	24	34.6	30	31.4	37.5	With guideposts	
FX11LA-120P/12-SV(71)	573-0005-5-71	120	12	35.5	30	40.6	36	37.4	43.5		YES
FX11LB- 60P/ 6-SV(71)	573-0012-0-71	60	6	17.5	12	22.6		19.4	25.5		TES
FX11LB- 80P/ 8-SV(71)	573-0013-3-71	80	8	23.5	18	28.6		25.4	31.5	Without guidenests	
FX11LB-100P/10-SV(71)	573-0014-6-71	100	10	29.5	24	34.6		31.4	37.5	-	
FX11LB-120P/12-SV(71)	573-0015-9-71	120	12	35.5	30	40.6		37.4	43.5		

[Specifications number] - **, (**)

(71): Tray packaging

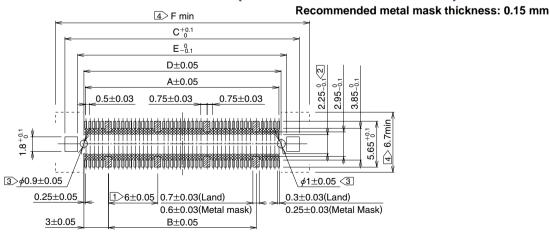
(91): Embossed tape packaging (Without pick-and-place tape)

(92): Embossed tape packaging (With pick-and-place tape)

Note 1: There is no polarity in terms of board mounting for this product.

Note 2: The coplanarity of this product's SMT leads is 0.1 mm or less.

Note 3: Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)



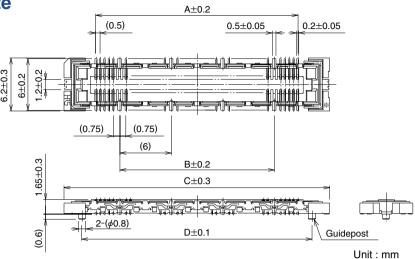
Note 1 Cross-hatched portions, totaling n places, indicate the ground circuits.

- 2 The cross-hatched area inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.
- 3 Not required in products without guideposts.

■Receptacle with ground Plate

• 2mm stacking height





43.4

40.2

Part Number	CL No.	Number of contacts		В	$\mid c \mid$	D	E	F	Remarks	RoHS	
Part Number	CL No.	Signal	Ground	Α .	В		ט	E	F	Hemarks	HOHS
FX11LA- 60S/ 6-SV(71)	573-0102-1-71	60	6	17.5	12	25	20.8	25.4	22.2		
FX11LA- 80S/ 8-SV(71)	573-0103-4-71	80	8	23.5	18	31	26.8	31.4	28.2	 With guideposts 	
FX11LA-100S/10-SV(71)	573-0104-7-71	100	10	29.5	24	37	32.8	37.4	34.2		
FX11LA-120S/12-SV(71)	573-0105-0-71	120	12	35.5	30	43	38.8	43.4	40.2		YES
FX11LB- 60S/ 6-SV(71)	573-0112-5-71	60	6	17.5	12	25		25.4	22.2		YES
FX11LB- 80S/ 8-SV(71)	573-0113-8-71	80	8	23.5	18	31		31.4	28.2	Without guidenests	
FX11LB-100S/10-SV(71)	573-0114-0-71	100	10	29.5	24	37		37.4	34.2	Without guideposts	

35.5

30

[Specifications number] - **, (**)

FX11LB-120S/12-SV(71)

(71): Tray packaging (Without pick-and-place tape)

(91): Embossed tape packaging (Without pick-and-place tape)

573-0115-3-71

(92): Embossed tape packaging (With pick-and-place tape)

Note 1: There is no polarity in terms of board mounting for this product.

Note 2: The coplanarity of this product's SMT leads is 0.1 mm or less.

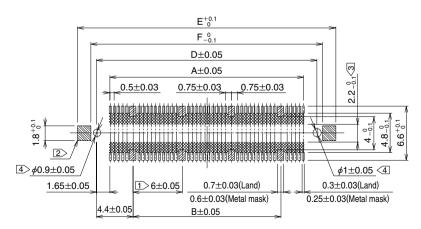
Note 3: Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)

120

♠ Recommended Land Pattern Dimensions (Metal Mask Dimensions)

12

Recommended metal mask thickness: 0.15 mm



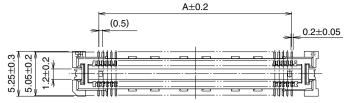
Note \square Cross-hatched portions, totaling n places, indicate the ground circuits.

- 2 Cross-hatched portions, 2 places on both sides, indicate the metal fittings.
- 3 The cross-hatched area inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.
- 4 Not required in products without guideposts.

■Header without ground Plate

2mm stacking height







Part Number	CL No.	Number of contacts	_	В	С	_	E	Remarks	RoHS
Part Number	OL NO.	Signal	Α	В	C	D		nemarks	нопо
FX11LA- 68P-SV(**)	573-0042-1-**	68	16.5	22.6	18	19.4	25.5		
FX11LA- 92P-SV(**)	573-0043-4-**	92	22.5	28.6	24	25.4	31.5	→ With guideposts	
FX11LA-116P-SV(**)	573-0044-7-**	116	28.5	34.6	30	31.4	37.5		
FX11LA-140P-SV(**)	573-0045-0-**	140	34.5	40.6	36	37.4	43.5		VEC
FX11LB- 68P-SV(**)	573-0052-5-**	68	16.5	22.6		19.4	25.5		YES
FX11LB- 92P-SV(**)	573-0053-8-**	92	22.5	28.6		25.4	31.5	Without guidenests	
FX11LB-116P-SV(**)	573-0054-0-**	116	28.5	34.6		31.4	37.5	Without guideposts	
FX11LB-140P-SV(**)	573-0055-3-**	140	34.5	40.6		37.4	43.5		

[Specifications number] - **, (**)

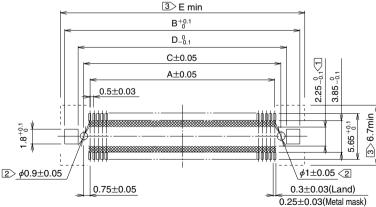
Blank: Tray packaging (Without pick-and-place tape)

(21): Embossed tape packaging (Without pick-and-place tape)

(22): Embossed tape packaging (With pick-and-place tape)

- Note 1: There is no polarity in terms of board mounting for this product.
- Note 2: The coplanarity of this product's SMT leads is 0.1 mm or less.
- Note 3: Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)

Recommended metal mask thickness: 0.15 mm

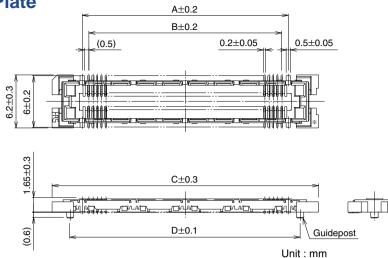


- Note 1 The cross-hatched area inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.
 - 2 Not required in products without guideposts.
 - 3 Do not mount a part other than this product in the area of . Doing so will prevent the engagement of this and the mating connector.

■Receptacle without ground Plate

• 2mm stacking height





Part Number CL No.		Number of contacts	Α	В	С	D	Remarks	RoHS
T dit Hambon	OE NO.	Signal					riomano	110110
FX11LA- 68S-SV(**)	573-0142-6-**	68	18	16.5	25	20.8		
FX11LA- 92S-SV(**)	573-0143-9-**	92	24	22.5	31	26.8	─ With guideposts	
FX11LA-116S-SV(**)	573-0144-1-**	116	30	28.5	37	32.8		
FX11LA-140S-SV(**)	573-0145-4-**	140	36	34.5	43	38.8		YES
FX11LB- 68S-SV(**)	573-0152-0-**	68	18	16.5	25	_		YES
FX11LB- 92S-SV(**)	573-0153-2-**	92	24	22.5	31	_	Without guidenests	
FX11LB-116S-SV(**)	573-0154-5-**	116	30	28.5	37	_	Without guideposts	
FX11LB-140S-SV(**)	573-0155-8-**	140	36	34.5	43	_		

[Specifications number] - **, (**)

Blank: Tray packaging (Without pick-and-place tape)

(21): Embossed tape packaging (Without pick-and-place tape) (22): Embossed tape packaging (With pick-and-place tape)

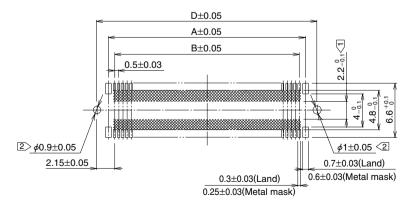
Note 1: There is no polarity in terms of board mounting for this product.

Note 2: The coplanarity of this product's SMT leads is 0.1 mm or less.

Note 3: Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)

♠ Recommended Land Pattern Dimensions (Metal Mask Dimensions)

Recommended metal mask thickness: 0.15 mm



Note 1 The cross-hatched area inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.

2 Not required in products without guideposts.

Stacking height: 2.5mm, 3mm

■Product Specifications

	Rated current	0.3 A (Note 1)	Operating temperature range	-55 to 85℃	Storage temperature range	-10 to +60°C (Note 2)
Rating	Rated voltage	50 V AC	Operating humidity range	Relative humidity 95% or less	Storage humidity range	40 to 70% (Note 2)
				(No condensation)		

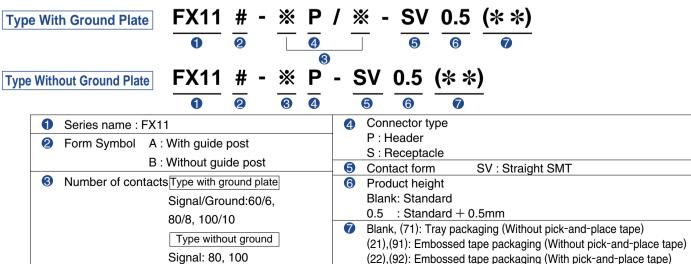
Item	Requirements	Conditions
1. Insulation resistance	100 MΩ or greater	Measured at 100 V DC
2. Voltage proof	No flashover or breakdown	150 V AC applied for one minute
3. Contact resistance	70 m $Ω$ or less	Measured at 100 mA
4. Vibration	No electrical discontinuity for 1 μ s or greater No damage, cracks, or parts looseness	Frequency: 10 to 55 Hz, amplitude of 0.75 mm in 3 directions, 10 cycles each
5. Shock	No electrical discontinuity for 1 μ s or longer No damage, cracks, or parts looseness	Acceleration of 490 m/s², 11ms duration, sine half-wave waveform,for 3 cycles in the both directions of each of the 3 axes
6. Damp heat (Steady state)	Contact resistance of 80 m Ω or less, insulation resistance of 100 M Ω or greater, no damage, cracks, or parts looseness	Temperature of 40℃, humidity of 90 to 95%, duration 96 h
7. Temperature cycle	Contact resistance of 80 m Ω or less, insulation resistance of 100 M Ω or greater, no damage, cracks, or parts looseness	Temperature: $-55^{\circ}\text{C} \rightarrow 15 \text{ to } 35^{\circ}\text{C} \rightarrow 85^{\circ}\text{C} \rightarrow 15 \text{ to } 35^{\circ}\text{C}$ Time: 30 min. \rightarrow 2 to 3 min. \rightarrow 30 min. \rightarrow 2 to 3 min. for 5 cycles
8. Durability	Contact resistance of 80 m Ω or less No damage, cracks, or parts looseness	50 times
Resistance to soldering heat	No melting of resin portion which affects performance	Reflow: At the recommended temperature profile Soldering iron temperature: 360°C for 5 seconds

Note 1: The term storage refers to an unused products prior to board mounting (including packing materials) that is being kept for a long period. The operating temperature and humidity range are applied to the non-conducting condition following board assembly.

■ Materials

Part	Material		Finish	Remarks
Insulator	LCP	Beige		UL94V-0
Contacto	Copper alloy	Header	Engagement Area: Gold plating of 0.1 μ m	
Contacts	Phosphor bronze	Receptacle	Termination Area: Flash plating	
Ground plate	Phosphor bronze	Tin plating		
Metal fitting	Dhoonhar bronzo	Tip plating		
Metal plate	Phosphor bronze	Tin plating		

■Ordering information

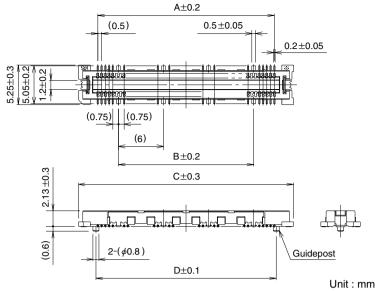


Note 2: Information contained in this catalog represents general requirements for this Series. Contact us for the drawings and specifications for a specific part number shown.

Header with ground plate

• 2.5mm stacking height





Part Number	CL No.	Number o	of contacts	_	В	С	D	E	F	Remarks	RoHS
Part Number	OL NO.	Signal	Ground	Α	Ь		U		Г	Tiemans	HUIS
FX11A- 60P/06-SV(71)	573-0502-0-71	60	6	17.5	12	22.6	18	19.4	25.5		
FX11A- 80P/08-SV(71)	573-0503-2-71	80	8	23.5	18	28.6	24	25.4	31.5	With guideposts	
FX11A-100P/10-SV(71)	573-0504-5-71	100	10	29.5	24	34.6	30	31.4	37.5		YES
FX11B- 60P/06-SV(71)	573-0512-3-71	60	6	17.5	12	22.6		19.4	25.5		YES
FX11B- 80P/08-SV(71)	573-0513-6-71	80	8	23.5	18	28.6		25.4	31.5	Without guideposts	
FX11B-100P/10-SV(71)	573-0514-9-71	100	10	29.5	24	34.6		31.4	37.5		

[Specifications number] - **, (**)

(71): Tray packaging (Without pick-and-place tape)

(91): Embossed tape packaging (Without pick-and-place tape)

(92) : Embossed tape packaging (With pick-and-place tape)

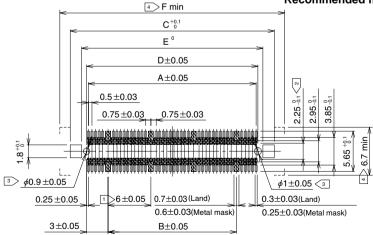
Note 1: There is no polarity in terms of board mounting for this product.

Note 2: The coplanarity of this product's SMT leads is 0.1 mm or less.

Note 3: Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)

♠ Recommended Land Pattern Dimensions (Metal Mask Dimensions)

Recommended metal mask thickness: 0.15 mm



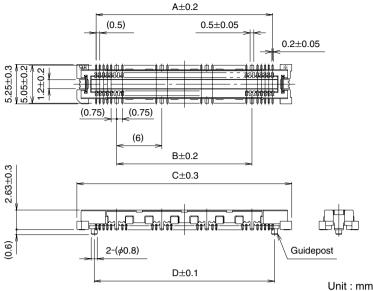
Note 1 Cross-hatched portions, totaling n places, indicate the ground circuits.

- 2) The cross-hatched area \implies inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.
- 3 Not required in products without guideposts.
- of this and the mating connector.

■Header with ground plate

3mm stacking height





										-	
Part Number	CL No.	Number o	f contacts		В	С	D	_	F	Domorico	RoHS
Part Number	CL NO.	Signal	Ground	Α	Ь			Е	Г	Remarks	110113
FX11A- 60P/ 6-SV0.5(71)	573-0602-4-71	60	6	17.5	12	22.6	18	19.4	25.5		
FX11A- 80P/ 8-SV0.5(71)	573-0603-7-71	80	8	23.5	18	28.6	24	25.4	31.5	With guideposts	
FX11A-100P/10-SV0.5(71)	573-0604-0-71	100	10	29.5	24	34.6	30	31.4	37.5		VEC
FX11B- 60P/ 6-SV0.5(71)	573-0612-8-71	60	6	17.5	12	22.6		19.4	25.5		YES
FX11B- 80P/ 8-SV0.5(71)	573-0613-0-71	80	8	23.5	18	28.6		25.4	31.5	Without guideposts	
FX11B-100P/10-SV0.5(71)	573-0614-3-71	100	10	29.5	24	34.6		31.4	37.5		

[Specifications number] - **, (**)

(71): Tray packaging (Without pick-and-place tape)

(91): Embossed tape packaging (Without pick-and-place tape)

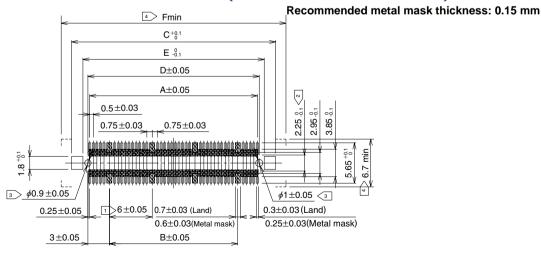
(92): Embossed tape packaging (With pick-and-place tape)

Note 1: There is no polarity in terms of board mounting for this product.

Note 2: The coplanarity of this product's SMT leads is 0.1 mm or less.

Note 3: Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)

♠ Recommended Land Pattern Dimensions (Metal Mask Dimensions)



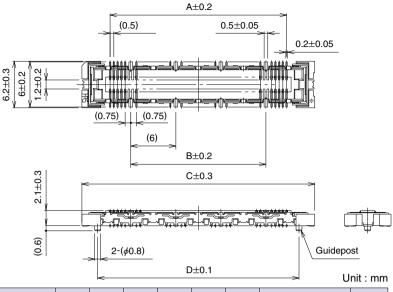
Note 1 Cross-hatched portions, totaling n places, indicate the ground circuits.

- 2 The cross-hatched area will inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.
- 3 Not required in products without guideposts.
- of this and the mating connector.

■Receptacle with ground plate

• 2.5mm, 3mm stacking height





Dowt Niveshou	CL No.	Number o	of contacts		_		_	_	F	Damada	Dallo
Part Number	CL No.	Signal	Ground	Α	В	С	D	E	F	Remarks	RoHS
FX11A- 60S/ 6-SV(71)	573-0702-9-71	60	6	17.5	12	25	20.8	25.4	22.2		
FX11A- 80S/ 8-SV(71)	573-0703-1-71	80	8	23.5	18	31	26.8	31.4	28.2	With guideposts	
FX11A-100S/10-SV(71)	573-0704-4-71	100	10	29.5	24	37	32.8	37.4	34.2		YES
FX11B- 60S/ 6-SV(71)	573-0712-2-71	60	6	17.5	12	25		25.4	22.2		TES
FX11B- 80S/ 8-SV(71)	573-0713-5-71	80	8	23.5	18	31		31.4	28.2	Without guideposts	
FX11B-100S/10-SV(71)	573-0714-8-71	100	10	29.5	24	37		37.4	34.2		

[Specifications number] - **, (**)

(71): Tray packaging (Without pick-and-place tape)

(91): Embossed tape packaging (Without pick-and-place tape)

(92): Embossed tape packaging (With pick-and-place tape)

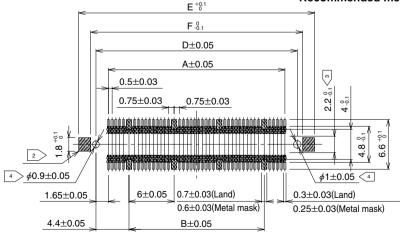
Note 1: There is no polarity in terms of board mounting for this product.

Note 2: The coplanarity of this product's SMT leads is 0.1 mm or less.

Note 3: Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)

♠ Recommended Land Pattern Dimensions (Metal Mask Dimensions)

Recommended metal mask thickness: 0.15 mm



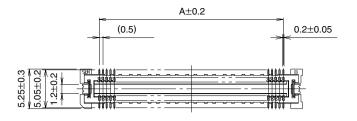
Note \square Cross-hatched portions, totaling n places, indicate the ground circuits.

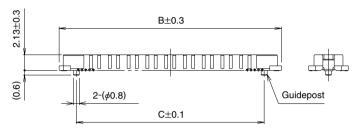
- 2 Cross-hatched portions, totaling 2 places, indicate the metal fittings.
- 3 The cross-hatched area inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.
- 4 Not required in products without guideposts.

■Header without ground Plate

● 2.5mm stacking height







Unit: mm

Part Number	CL No.	Number of contacts Signal	Α	В	С	D	E	Remarks	RoHS
FX11A- 80P-SV(**)	573-0548-0-**	80	19.5	24.6	20	21.4	27.5	With guideposts	
FX11A-100P-SV(**)	573-0543-7-**	100	24.5	29.6	25	26.4	32.5	with guideposts	VEC
FX11B- 80P-SV(**)	573-0558-4-**	80	19.5	24.6	_	21.4	27.5	Without guideposts	YES
FX11B-100P-SV(**)	573-0553-0-**	100	24.5	29.6		26.4	32.5	will lout guideposts	

[Specifications number] - **, (**)

Blank: Tray packaging (Without pick-and-place tape)

(21) : Embossed tape packaging (Without pick-and-place tape)

(22) : Embossed tape packaging (With pick-and-place tape)

Note 1: There is no polarity in terms of board mounting for this product.

Note 2: The coplanarity of this product's SMT leads is 0.1 mm or less.

Note 3: Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)

♠ Recommended Land Pattern Dimensions (Metal Mask Dimensions)

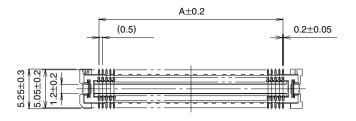
Recommended metal mask thickness: 0.15 mm 3>E min $B_{0}^{+0.1}$ D-0.1 C±0.05 A±0.05 0.5±0.03 2 $\phi 0.9 \pm 0.05$ φ1±0.05 <2 0.25±0.05 0.3(Land) 0.25±0.03(Metal mask)

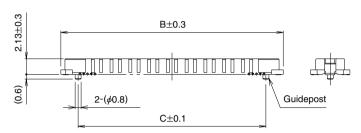
- Note 1 The cross-hatched area inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.
 - 2 Not required in products without guideposts.
 - of this and the mating connector.

■Header without ground Plate

3mm stacking height







Unit: mm

Part Number	CL No.	Number of contacts Signal	Α	В	С	D	E	Remarks	RoHS
FX11A- 80P-SV0.5(**)	573-0648-5-**	80	19.5	24.6	20	21.4	27.5	Mith avidonacta	
FX11A-100P-SV0.5(**)	573-0643-1-**	100	24.5	29.6	25	26.4	32.5	With guideposts	\/F0
FX11B- 80P-SV0.5(**)	573-0658-9-**	80	19.5	24.6	_	21.4	27.5	Without guidenests	YES
FX11B-100P-SV0.5(**)	573-0653-5-**	100	24.5	29.6		26.4	32.5	Without guideposts	

[Specifications number] - **, (**)

Blank: Tray packaging (Without pick-and-place tape)

(21): Embossed tape packaging (Without pick-and-place tape)

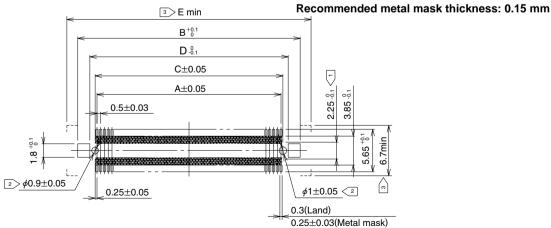
(22): Embossed tape packaging (With pick-and-place tape)

Note 1: There is no polarity in terms of board mounting for this product.

Note 2: The coplanarity of this product's SMT leads is 0.1 mm or less.

Note 3: Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)

♠ Recommended Land Pattern Dimensions (Metal Mask Dimensions)

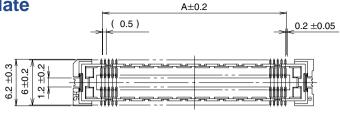


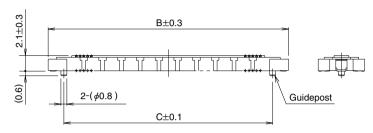
- Note 1 The cross-hatched area inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.
 - 2 Not required in products without guideposts.
 - of this and the mating connector.

■Receptacle without ground plate

• 2.5mm, 3mm stacking height







Unit: mm

Part Number	CL No.	Number of contacts Signal	А	В	С	D	Е	Remarks	RoHS
FX11A- 80S-SV(**)	573-0748-0-**	80	19.5	27	22.8	27.4	24.2	Marile e de la conte	
FX11A-100S-SV(**)	573-0743-6-**	100	24.5	32	27.8	32.4	29.2	With guideposts	\/F0
FX11B- 80S-SV(**)	573-0758-3-**	80	19.5	27		27.4	24.2	Without guidenests	YES
FX11B-100S-SV(**)	573-0753-0-**	100	24.5	32		32.4	29.2	Without guideposts	

[Specifications number] - **, (**)

Blank: Tray packaging (Without pick-and-place tape)

(21) : Embossed tape packaging (Without pick-and-place tape)

(22) : Embossed tape packaging (With pick-and-place tape)

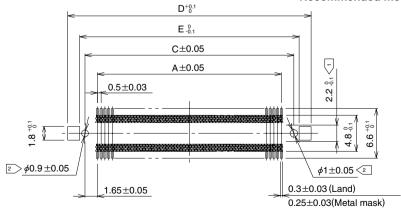
Note 1: There is no polarity in terms of board mounting for this product.

Note 2: The coplanarity of this product's SMT leads is 0.1 mm or less.

Note 3: Please order embossed tape packaged items by the reel. (One reel holds 1,000 pieces.)

♠ Recommended Land Pattern Dimensions (Metal Mask Dimensions)

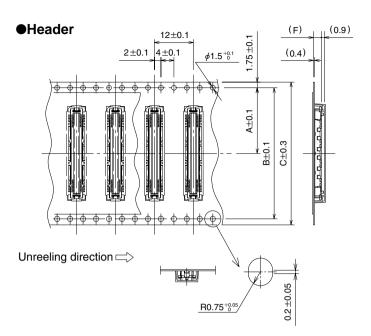
Recommended metal mask thickness: 0.15 mm



Note 1 The cross-hatched area inside the SMT land may come into contact with the connector contacts and thus care should be taken that the pattern does not extend beyond the SMT land width.

2 Not required in products without guideposts.

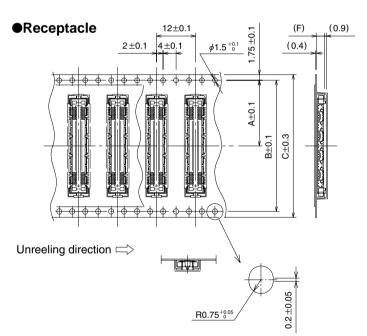
● Embossed Carrier Tape Dimensions



					Uni	t : mm
Insertion Connector	Α	В	C	D	Е	F
FX11L#- 60P/ 6-SV	20.2	40.4	44	45.5	50.5	
FX11L#- 80P/ 8-SV	20.2	40.4	44	45.5	30.5	
FX11L#-100P/10-SV	26.2	52.4	56	59	64	
FX11L#-120P/12-SV	20.2	32.4	30	39	04	1.98
FX11L#- 68P -SV	20.2	40.4	44	45.5	50.5	1.90
FX11L#- 92P -SV	20.2	40.4	44	45.5	30.5	
FX11L#-116P -SV	26.2	52.4	56	59	64	
FX11L#-140P -SV	20.2	32.4	30	39	04	
FX11 #- 60P/ 6-SV	20.2	40.4	44	45.5	50.5	
FX11 #- 80P/ 8-SV	20.2	40.4	44	45.5	50.5	
FX11 #-100P/10-SV	26.2	52.4	56	59	64	2.48
FX11 #- 80P -SV	20.2	40.4	44	45.5	50.5	
FX11 #-100P -SV	20.2	40.4	44	45.5	30.5	
FX11 #- 60P/ 6-SV0.5	20.2	40.4	44	45.5	50.5	
FX11 #- 80P/ 8-SV0.5	20.2	40.4	44	45.5	30.5	
FX11 #-100P/10-SV0.5	26.2	52.4	56	59	64	2.98
FX11 #- 80P -SV0.5	20.2	40.4	44	45.5	50.5	
FX11 #-100P -SV0.5	20.2	40.4	44	45.5	50.5	

Note 1: There is no polarity in terms of embossed tape packaging for this product.

Note 2: Left figure is representative of products with ground plates.

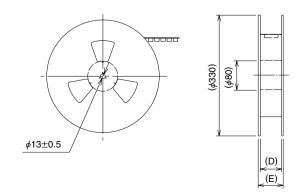


					Uni	t:mm
Insertion Connector	Α	В	O	D	Е	F
FX11L#- 60S/ 6-SV	20.2	40.4	44	45.5	50.5	
FX11L#- 80S/ 8-SV	20.2	40.4	44	45.5	30.5	
FX11L#-100S/10-SV	26.2	52.4	56	59	64	
FX11L#-120S/12-SV	20.2	52.4	50	59	04	2
FX11L#- 68S -SV	20.2	40.4	44	45.5	50.5	
FX11L#- 92S -SV	20.2	40.4	44	45.5	50.5	
FX11L#-116S -SV	26.2	52.4	56	59	64	
FX11L#-140S -SV	20.2	52.4	50	59	04	
FX11 #- 60S/ 6-SV	20.2	40.4	44	45.5	50.5	
FX11 #- 80S/ 8-SV	20.2	40.4	44	45.5	50.5	
FX11 #-100S/10-SV	26.2	52.4	56	59	64	2.45
FX11 #- 80S -SV	20.2	40.4	44	45.5	50.5	
FX11 #-100S -SV	20.2	40.4	44	45.5	50.5	

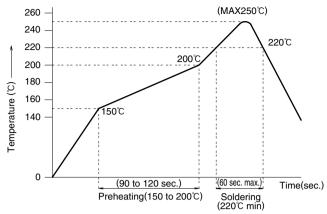
Note 1: There is no polarity in terms of embossed tape packaging for this product.

Note 2: Left figure is representative of products with ground plates.

●Reel Dimensions



●Recommended Temperature Profile



Note: The temperature profile indicates the maximum temperature of the connector surfaces at the highest point from the PCB mounting surface.

HRS test conditions

Test boardGlass epoxy 60mm×35mm×1.6mm thick

Solder method : Reflow

Solder composition: Paste,96.5%Sn/3%Ag/0.5%Cu

Metal mask : 0.15mm thick
Reflow cycles : 2 cycles

The temperature profile is based on the above conditions. In individual applications the actual temperature may vary, depending on solder paste type, volume/thickness and board size/thickness. Consult your solder paste and equipment manufacturer for specific recommendations.

Washing Conditions

Organic Solvent Washing

Solvent	Room temperature washing	Heated washing
IPA(Isopropyl alcohol)	Yes	Yes
HCFC(Hydrochlorofluorocarbon)	Yes	Yes

Water Type Washing

When using water type cleaning agents (e.g., terpene, and alkali saponifiers), select the cleaning agent based on the documentation issued by the various manufacturers of cleaning agents which describes the effects on metals and resins. Be careful that parts are not left with moisture remaining on them.

Washing Precautions

Residual flux or cleaning agent on the contacts when washing with organic solvents or water type cleaners can give rise to the deterioration of electrical performance. In this regard it is important to check whether a thorough washing has been performed.

◆Connector Handling Precautions

1. Allowable Creepage Dimensions at Time of Mating

[Stacking height: 2mm]

The effective coupling length of this product is 0.55 mm for the signal portion and the ground portion. The creepage of the header and receptacle at the time of mating should be within 0.18 mm of the completely coupled condition.

[Stacking height: 2.5mm, 3mm]

The effective coupling length of this product is 1 mm for the signal portion and 0.7mm for the ground portion. The creepage of the header and receptacle at the time of mating should be within 0.4 mm of the completely coupled condition.

2. Compatibility

2mm type and 2.5mm, 3mm type, with ground plate type and without ground type are not mated with each other.

3. Retension of Boards

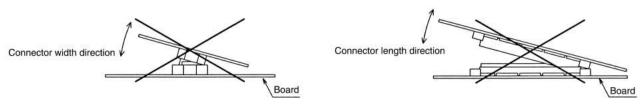
Avoid the support of boards by connectors alone and adopt a board locking measure that does not rely on the connectors.

4. Solder Repair

Flux may rise as far as the contact portion of the connector depending on the flux coating and other factors at the time of repair. This will cause poor contact reliability; therefore, before use, the aforementioned washing conditions should be taken into consideration prior to connector washing.

5. Miscellaneous

- ·Note that excessive twisting while inserting or withdrawing connectors will cause damage.
- •The shade of the molded items may vary somewhat depending on the manufacturing lot; however, this does not affect performance.



FX11 Series●0.5mm Pitch Connectors with Ground Plate for 2mm to 3mm Board-to-Board Connections
NOTES:

FX11 Series●0.5mm Pitch Connectors with Ground Plate for 2mm to 3mm Board-to-Board Connections
NOTES:

USA:

HIROSE ELECTRIC (U.S.A.), INC. Headquarters

2688 Westhills Court, Simi Valley, CA 93065-6235

Phone: +1-805-522-7958 Fax: +1-805-522-3217 http://www.hiroseusa.com

THE NETHERLANDS: HIROSE ELECTRIC EUROPE B.V.

Hogehillweg #8 1101 CC Amsterdam Z-0

Phone: +31-20-6557460 Fax: +31-20-6557469 http://www.hiroseeurope.com

CHINA:

HIROSE ELECTRIC (SHANGHAI) CO., LTD.

1601, Henderson Metropolitan, NO.300, East Nanjing Road, Huangpu District, Shanghai, China 200001

Phone: +86-21-6391-3355 Fax: +86-21-6391-3335 http://www.hirose-china.com.cn

HONG KONG:

HIROSE ELECTRIC HONGKONG TRADING CO., LTD.

Room 1001, West Wing, Tsim Sha Tsui Centre, 66 Mody Road, Tsim Sha Tsui East, Kowloon, Hong Kong

Phone: +852-2803-5338 Fax: +852-2591-6560

http://www.hirose-hongkong.com.hk

SINGAPORE:

HIROSE ELECTRIC SINGAPORE PTE. LTD.

10 Anson Road #26-16 International Plaza 079903

Phone: +65-6324-6113 Fax: +65-6324-6123

http://www.hirose-singapore.com.sg

HIROSE ELECTRIC (U.S.A.), INC. San Jose Office

20400 Stevens Creek Blvd., Ste 250, Cupertino,

CA 95014

Phone: +1-408-253-9640 Fax: +1-408-253-9641 http://www.hiroseusa.com

GERMANY:

HIROSE ELECTRIC EUROPE B.V. GERMAN BRANCH

Herzog-Carl-Strasse 4 D-73760 Ostfildern

(Scharnhauser Park) Phone: +49-711-4560-02-1 Fax: +49-711-4560-02-299 http://www.hirose.de

CHINA:

HIROSE ELECTRIC (SHANGHAI) CO., LTD. BEIJING BRANCH

A1001, Ocean International Center, Building 56# East 4th Ring Middle Road, Chao Yang District, Beijing, 100025

Phone: +86-10-5165-9332 Fax: +86-10-5908-1381 http://www.hirose-china.com.cn

TAIWAN:

HIROSE ELECTRIC TAIWAN CO., LTD.

103 8F, No.87, Zhengzhou Rd., Taipei

Phone: +886-2-2555-7377 Fax: +886-2-2555-7350

http://www.hirose-taiwan.com.tw

INDIA:

HIROSE ELECTRIC SINGAPORE PTE. LTD. BANGALORE LIAISON OFFICE

Unit No.03, Ground Floor, Explorer Building International Tech Park Whitefield Road, Bangalore 560066 Karnataka, India

Phone: +65-6324-6113 Fax: +65-6324-6123

http://www.hirose-singapore.com.sg

USA:

HIROSE ELECTRIC (U.S.A.), INC. Detroit Office (Automotive)

37677 Professional Center Drive, Suite #100C Livonia, MI 48154

Phone: +1-734-542-9963 Fax: +1-734-542-9964 http://www.hiroseusa.com

UNITED KINGDOM:

HIROSE ELECTRIC EUROPE B.V. UK BRANCH

First Floor, St Andrews House, Caldecotte Lake Business Park, Milton Keynes MK7 8LE

Phone: +44-1908-369060 Fax: +44-1908-369078 http://www.hirose.co.uk

CHINA:

HIROSE ELECTRIC TECHNOLOGIES (SHENZHEN) CO., LTD.

Room 09-13, 19/F, Office Tower Shun Hing Square, Di Wang Commercial Centre 5002, ShenNanDong Road, ShenZhen City, Guangdong Province, 518008

Phone: +86-755-8207-0851 Fax: +86-755-8207-0873 http://www.hirose-china.com.cn

KOREA:

HIROSE KOREA CO., LTD.

1261-10, Jeoungwhang-Dong, Shihung-City,

Kyunggi-Do 429-450

Phone: +82-31-496-7000.7124 Fax: +82-31-496-7100

http://www.hirose.co.kr



HIROSE ELECTRIC CO.,LTD.

6-3, Nakagawa Chuoh-2-Chome, Tsuzuki-Ku, Yokohama-Shi 224-8540. JAPAN TEL: +81-45-620-3526 Fax: +81-45-591-3726

http://www.hirose.com

http://www.hirose-connectors.com